

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT2681438

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
YUSUKE TAGAWA		01/08/2014
RECEIVING PARTY DATA		
Name:	SHIMADZU CORPORATION	
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City:	KYOTO-SHI, KYOTO	
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PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	14154922	
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NAME OF SUBMITTER:	TOMOKI TANIDA	
Signature:	/Tomoki Tanida/	
Date:	01/14/2014	
Total Attachments: 1 source=Assignment 090040-0050#page1.tif		

Docket No.: \_\_\_\_\_

ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

Yusuke TAGAWA

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

SHIMADZU CORPORATION

a Corporation organized under the law of Japan, located at 1, Nishinokyo-Kuwabaracho,  
Nakagyo-ku, Kyoto-shi, Kyoto 604-8511 Japan

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

RADIOGRAPHIC APPARATUS AND AN IMAGE PROCESSING METHOD THEREFORE

(a) for which an application for United States Letters Patent was filed on \_\_\_\_\_, and identified by United States Serial No. \_\_\_\_\_; or

(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

INVENTOR

DATE SIGNED

Yusuke Tagawa

8 / January, 2014

Name: Yusuke TAGAWA